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Vishay Siliconix

# P-Channel 30-V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	-30					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.032					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.049					
Q <sub>g</sub> typ. (nC)	13					
I <sub>D</sub> (A) <sup>d</sup>	-9					
Configuration	Single					

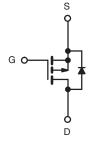
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>



### **APPLICATIONS**

- · Load switch
- · Battery switch



P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si4431CDY-T1-E3			
Lead (Pb)-free and halogen-free	Si4431CDY-T1-GE3			

<b>ABSOLUTE MAXIMUM RATINGS (TA</b>	$_{\Lambda}$ = 25 °C, unless other	wise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		$V_{DS}$	-30	V	
Gate-source voltage		$V_{GS}$	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-9		
	T <sub>C</sub> = 70 °C	1 , [	-7.2		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-7 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		-5.6 <sup>a, b</sup>	A	
Pulsed drain current	I <sub>DM</sub>	-30			
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-3.5		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-2.1 <sup>a, b</sup>	1	
	T <sub>C</sub> = 25 °C		4.2		
Maximum power dissipation	T <sub>C</sub> = 70 °C		2.7	١,,,	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>sta</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	R <sub>thJA</sub>	40	50	°C/W	
Maximum junction-to-foot	Steady state	R <sub>thJF</sub>	24	30	C/VV	

#### **Notes**

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 95 °C/W
- d. Based on T<sub>C</sub> = 25 °C

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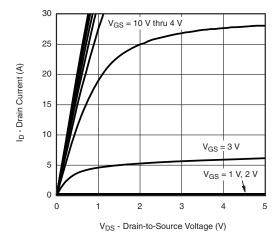
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA	-	-31	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-2.5	V	
Gate-source leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zoro gata valtaga drain aurrent		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	-	-	-1	μА	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-5		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-20	-	-	Α	
Drain actures on state registeres 3	В	$V_{GS} = -10 \text{ V}, I_D = -7 \text{ A}$	-	0.026	0.032	1 _	
Drain-source on-state resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5 \text{ V}, I_D = -5.6 \text{ A}$	-	0.037	0.049	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -7 \text{ A}$	-	18	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	1006	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	180	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	145	-		
Tabella discolaria	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -7 \text{ A}$	-	25	38	nC	
Total gate charge	$Q_g$		-	13	20		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7 \text{ A}$	-	3.5	-		
Gate-drain charge	Q <sub>gd</sub>		-	5.5	-		
Gate resistance	$R_g$	f = 1 MHz	0.4	2	4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20		
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 2.7 $\Omega$	-	13	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -5.6 A, $V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	23	35		
Fall time	t <sub>f</sub>		-	9	18	1	
Turn-on delay time	t <sub>d(on)</sub>		-	38	57	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 2.7 $\Omega$	-	89	134		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -5.6 A, $V_{GEN}=$ -4.5 V, $R_g$ = 1 $\Omega$	-	22	33		
Fall time	t <sub>f</sub>		-	11	17		
Drain-Source Body Diode Characteri	stics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-3.5	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	-30	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -5.6 A, V <sub>GS</sub> = 0 V	-	-0.71	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	22	33	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -5.6 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	17	26	nC	
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	13	-		
Reverse recovery rise time	t <sub>b</sub>		-	9	-	ns	

## Notes

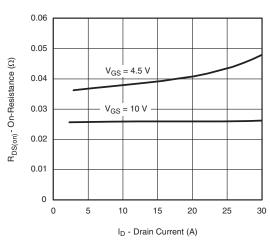
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

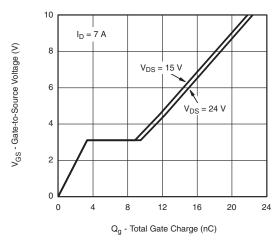




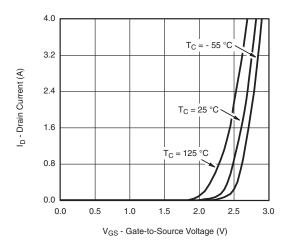
### **Output Characteristics**



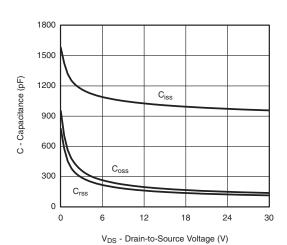
On-Resistance vs. Drain Current



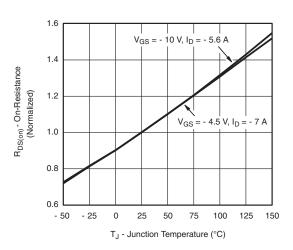
**Gate Charge** 



**Transfer Characteristics** 

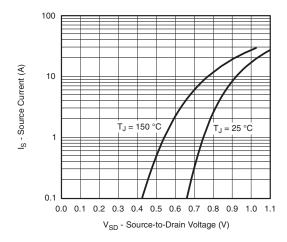


Capacitance

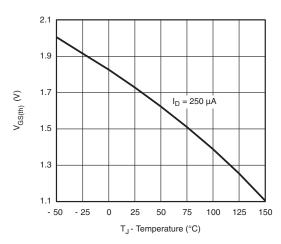


On-Resistance vs. Junction Temperature

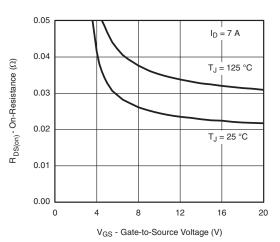




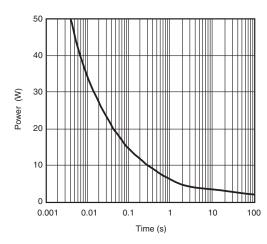
### **Source-Drain Diode Forward Voltage**



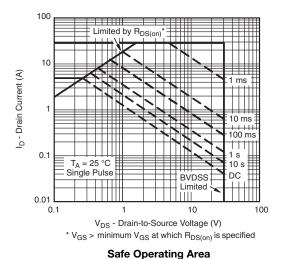
**Threshold Voltage** 



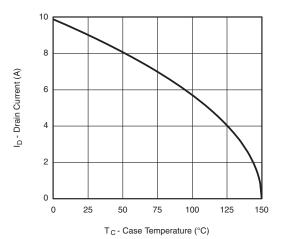
On-Resistance vs. Gate-to-Source Voltage



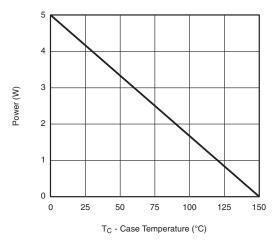
Single Pulse Power, Junction-to-Ambient

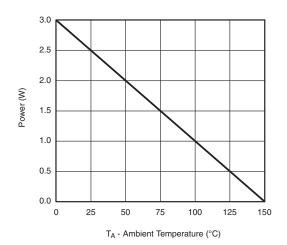






### Current Derating a





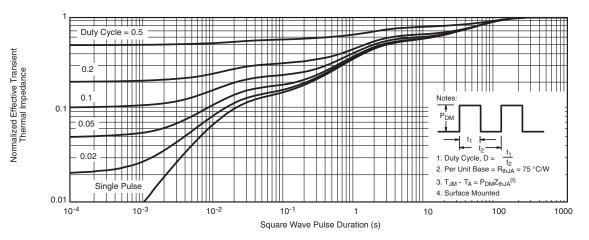
Power, Junction-to-Foot

Power Derating, Junction-to-Ambient

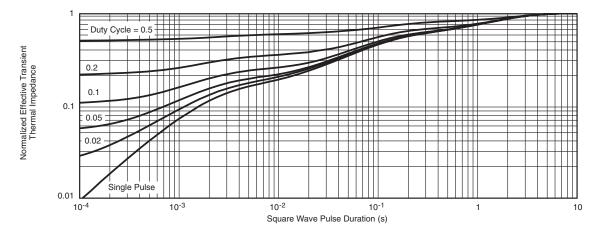
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCH			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018 0.026			
FCN: C-06527-Bey   11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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